

Data Sheet Issue:- 3

# Phase Control Thyristor Types N2543ZC240 to N2543ZC300

Old Type No.: N880CH24-30

Absolute Maximum Ratings

	VOLTAGE RATINGS	MAXIMUM LIMITS	UNITS
V <sub>DRM</sub>	Repetitive peak off-state voltage, (note 1)	2400-3000	V
V <sub>DSM</sub>	Non-repetitive peak off-state voltage, (note 1)	2400-3000	V
V <sub>RRM</sub>	Repetitive peak reverse voltage, (note 1)	2400-3000	V
V <sub>RSM</sub>	Non-repetitive peak reverse voltage, (note 1)	2500-3100	V

	OTHER RATINGS	MAXIMUM LIMITS	UNITS
I <sub>T(AVM)</sub>	Maximum average on-state current, T <sub>sink</sub> =55°C, (note 2)	2543	А
I <sub>T(AVM)</sub>	Maximum average on-state current. T <sub>sink</sub> =85°C, (note 2)	1811	А
I <sub>T(AVM)</sub>	Maximum average on-state current. T <sub>sink</sub> =85°C, (note 3)	1160	А
I <sub>T(RMS)</sub>	Nominal RMS on-state current, T <sub>sink</sub> =25°C, (note 2)	4922	А
I <sub>T(d.c.)</sub>	D.C. on-state current, T <sub>sink</sub> =25°C, (note 4)	4509	А
I <sub>TSM</sub>	Peak non-repetitive surge t <sub>p</sub> =10ms, V <sub>m</sub> =0.6V <sub>RRM</sub> , (note 5)	32	kA
I <sub>TSM2</sub>	Peak non-repetitive surge t <sub>p</sub> =10ms, V <sub>m</sub> ≤10V, (note 5)	39	kA
l²t	$I^{2}t$ capacity for fusing $t_{p}$ =10ms, $V_{m}$ =0.6 $V_{RRM}$ , (note 5)	5.12×10 <sup>6</sup>	A <sup>2</sup> s
l²t	$I^{2}t$ capacity for fusing $t_{p}$ =10ms, $V_{m}$ ≤10V, (note 5)	7.61×10 <sup>6</sup>	A <sup>2</sup> s
(-1:/-14)	Critical rate of rise of on-state current (repetitive), (Note 6)	150	A/µs
(di/dt) <sub>cr</sub>	Critical rate of rise of on-state current (non-repetitive), (Note 6)	300	A/µs
V <sub>RGM</sub>	Peak reverse gate voltage	5	V
P <sub>G(AV)</sub>	Mean forward gate power	4	W
$P_{GM}$	Peak forward gate power	30	W
Т <sub>НS</sub>	Operating temperature range	-40 to +125	°C
T <sub>stg</sub>	Storage temperature range	-40 to +150	°C

Notes: -

- 1) De-rating factor of 0.13% per °C is applicable for  $T_j$  below 25°C.
- 2) Double side cooled, single phase; 50Hz, 180° half-sinewave.
- 3) Single side cooled, single phase; 50Hz, 180° half-sinewave.
- 4) Double side cooled.
- 5) Half-sinewave, 125°C T<sub>j</sub> initial.
- 6)  $V_D$ =67%  $V_{DRM}$ ,  $I_{TM}$ =1000A,  $I_{FG}$ =2A,  $t_r \le 0.5 \mu s$ ,  $T_{case}$ =125°C.

## **Characteristics**

	PARAMETER	MIN.	TYP.	MAX.	TEST CONDITIONS (Note 1)	UNITS
Vtm	Maximum peak on-state voltage	-	-	1.6	I <sub>TM</sub> =3000A	V
V <sub>T0</sub>	Threshold voltage	-	-	0.78		V
r <sub>⊤</sub>	Slope resistance	-	-	0.274		mΩ
(dv/dt) <sub>cr</sub>	Critical rate of rise of off-state voltage	1000	-	-	V <sub>D</sub> =80% V <sub>DRM</sub> , linear ramp, Gate O/C	V/µs
I <sub>DRM</sub>	Peak off-state current	-	-	200	Rated V <sub>DRM</sub>	mA
I <sub>RRM</sub>	Peak reverse current	-	-	200	Rated V <sub>RRM</sub>	mA
V <sub>GT</sub>	Gate trigger voltage	-	-	3.0		V
I <sub>GT</sub>	Gate trigger current	-	-	300	$T_j=25^{\circ}C, V_D=10V, I_T=3A$	mA
$V_{GD}$	Non-trigger gate voltage, (Note 7)	-	-	0.25	Rated V <sub>DRM</sub>	V
I <sub>H</sub>	Holding current	-	-	1000	T <sub>j</sub> =25°C	mA
t <sub>gd</sub>	Gate controlled turn-on delay time	-	0.5	1.0	V <sub>D</sub> =67%V <sub>DRM</sub> , I <sub>TM</sub> =2000A, di/dt=10A/µs,	μs
t <sub>gt</sub>	Turn-on time	-	1.0	2.0	I <sub>FG</sub> =2A, t <sub>r</sub> =0.5μs, T <sub>j</sub> =25°C	
Q <sub>rr</sub>	Recovered Charge	-	7750	-		μC
Q <sub>ra</sub>	Recovered Charge, 50% chord	-	3900	5400	I <sub>TM</sub> =4000A, t <sub>p</sub> =1000µs, di/dt=10A/µs,	μC
l <sub>rm</sub>	Reverse recovery current	-	190	-	V <sub>r</sub> =50V	А
t <sub>rr</sub>	Reverse recovery time, 50% chord	-	40.0	-		μs
1	Turn off time	-	350	-	I <sub>TM</sub> =4000A, t <sub>p</sub> =1000μs, di/dt=10A/μs, V <sub>r</sub> =50V, V <sub>dr</sub> =80%V <sub>DRM</sub> , dV <sub>dr</sub> /dt=20V/μs	
tq	Turn-off time	-	400	-	I <sub>TM</sub> =4000A, t <sub>p</sub> =1000μs, di/dt=10A/μs, V <sub>r</sub> =50V, V <sub>dr</sub> =80%V <sub>DRM</sub> , dV <sub>dr</sub> /dt=200V/μs	μs
Р	Thermel registered, junction to bestainly	-	-	0.011	Double side cooled	K/W
R <sub>thJK</sub>	Thermal resistance, junction to heatsink	-	-	0.022	Single side cooled	K/W
F	Mounting force	27	-	47		kN
Wt	Weight	-	1.7	-		kg

Notes: -

1) Unless otherwise indicated  $T_j=125^{\circ}C$ .

#### Notes on Ratings and Characteristics

1.0 Voltage Grade Table

Voltage Grade	V <sub>drm</sub> V <sub>dsm</sub> V <sub>rrm</sub> V	V <sub>RSM</sub> V	V <sub>D</sub> V <sub>R</sub> DC V
24	2400	2500	1450
26	2600	2700	1550
28	2800	2900	1650
30	3000	3100	1750

#### 2.0 Extension of Voltage Grades

This report is applicable to other voltage grades when supply has been agreed by Sales/Production.

#### 3.0 De-rating Factor

A blocking voltage de-rating factor of 0.13%/°C is applicable to this device for T<sub>j</sub> below 25°C.

#### 4.0 Repetitive dv/dt

Standard dv/dt is 1000V/µs.

#### 5.0 Snubber Components

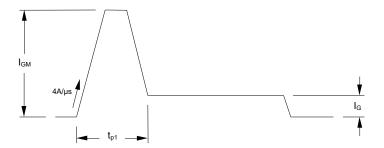
When selecting snubber components, care must be taken not to use excessively large values of snubber capacitor or excessively small values of snubber resistor. Such excessive component values may lead to device damage due to the large resultant values of snubber discharge current. If required, please consult the factory for assistance.

#### 6.0 Rate of rise of on-state current

The maximum un-primed rate of rise of on-state current must not exceed  $300A/\mu s$  at any time during turn-on on a non-repetitive basis. For repetitive performance, the on-state rate of rise of current must not exceed  $150A/\mu s$  at any time during turn-on. Note that these values of rate of rise of current apply to the total device current including that from any local snubber network.

#### 7.0 Gate Drive

The nominal requirement for a typical gate drive is illustrated below. An open circuit voltage of at least 30V is assumed. This gate drive must be applied when using the full di/dt capability of the device.



The magnitude of  $I_{GM}$  should be between five and ten times  $I_{GT}$ , which is shown on page 2. Its duration  $(t_{p1})$  should be 20µs or sufficient to allow the anode current to reach ten times  $I_L$ , whichever is greater. Otherwise, an increase in pulse current could be needed to supply the necessary charge to trigger. The 'back-porch' current  $I_G$  should remain flowing for the same duration as the anode current and have a magnitude in the order of 1.5 times  $I_{GT}$ .

#### 8.0 Computer Modelling Parameters

8.1 Device Dissipation Calculations

$$I_{AV} = \frac{-V_0 + \sqrt{V_0^2 + 4 \cdot ff \cdot r_s \cdot W_{AV}}}{2 \cdot ff \cdot r_s} \quad \text{and:} \quad \begin{aligned} W_{AV} &= \frac{\Delta T}{R_{th}} \\ \Delta T &= T_{j \max} - T_{Hs} \end{aligned}$$

Where  $V_{T0}$ =0.78V, r<sub>T</sub>=0.274m $\Omega$ ,

 $R_{th}$  = Supplementary thermal impedance, see table below and

ff = Form factor, see table below.

Supplementary Thermal Impedance							
Conduction Angle	30°	60°	90°	120°	180°	270°	d.c.
Square wave Double Side Cooled	0.0124	0.0122	0.0121	0.0119	0.0117	0.0113	0.011
Square wave Single Side Cooled	0.0249	0.0248	0.0247	0.0246	0.0244	0.0241	0.022
Sine wave Double Side Cooled	0.0168	0.0140	0.0131	0.0118	0.0112		
Sine wave Single Side Cooled	0.0249	0.0247	0.0246	0.0244	0.0241		

Form Factors							
Conduction Angle	30°	60°	90°	120°	180°	270°	d.c.
Square wave	3.464	2.449	2	1.732	1.414	1.149	1
Sine wave	3.98	2.778	2.22	1.879	1.57		

8.2 Calculating VT using ABCD Coefficients

The on-state characteristic  $I_T$  vs.  $V_T$ , on page 6 is represented in two ways;

- (i) the well established  $V_0$  and  $r_s$  tangent used for rating purposes and
- (ii) a set of constants A, B, C, D, forming the coefficients of the representative equation for  $V_T$  in terms of  $I_T$  given below:

$$V_T = A + B \cdot \ln(I_T) + C \cdot I_T + D \cdot \sqrt{I_T}$$

The constants, derived by curve fitting software, are given below for both hot and cold characteristics. The resulting values for  $V_T$  agree with the true device characteristic over a current range, which is limited to that plotted.

125°C Coefficients				
А	1.307753			
В	-0.1906143			
С	4.623129×10 <sup>-5</sup>			
D	0.03065344			

8.3 D.C. Thermal Impedance Calculation

$$r_t = \sum_{p=1}^{p=n} r_p \cdot \left( 1 - e^{\frac{-t}{\tau_p}} \right)$$

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Where p = 1 to *n*, *n* is the number of terms in the series and:

- t = Duration of heating pulse in seconds.
- $r_t$  = Thermal resistance at time t.
- $r_p$  = Amplitude of  $p_{th}$  term.

 $\tau_p$  = Time Constant of r<sub>th</sub> term.

The coefficients for this device are shown in the tables below:

D.C. Double Side Cooled						
Term 1 2 3 4						
<b>r</b> p	6.72×10 <sup>-3</sup>	2.78×10 <sup>-3</sup>	9.476×10 <sup>-4</sup>	7.12×10 <sup>-4</sup>		
τρ	1.0226	0.226	0.0586	9.06×10 <sup>-3</sup>		

	D.C. Single Side Cooled						
Term 1 2 3 4							
<i>r</i> <sub>p</sub>	0.01688	4.42×10 <sup>-3</sup>	1.76×10 <sup>-3</sup>	8.72×10 <sup>-4</sup>			
τρ	7.055	0.5206	0.1198	0.0128			

9.0 Reverse recovery ratings

(i)  $Q_{ra}$  is based on 50% Irm chord as shown in Fig. 1

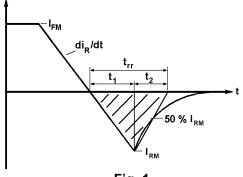


Fig. 1

(ii)  $Q_{rr}$  is based on a 150µs integration time i.e.

$$Q_{rr} = \int_{0}^{150\,\mu s} i_{rr}.dt$$

(iii) 
$$K Factor = \frac{t1}{t2}$$

## <u>Curves</u>

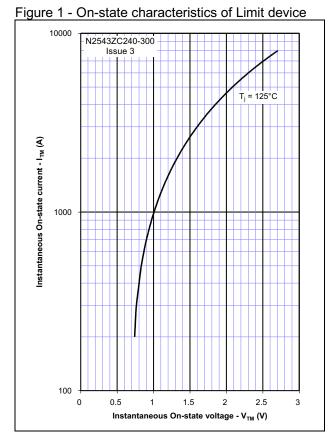
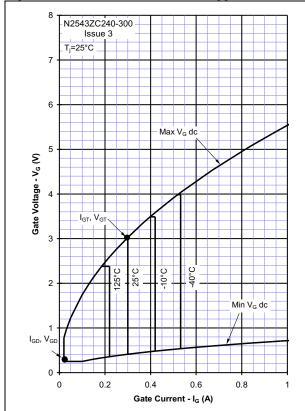


Figure 3 - Gate Characteristics - Trigger Limits



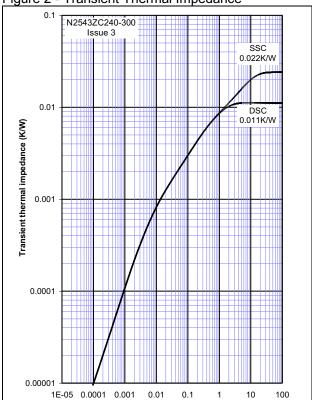
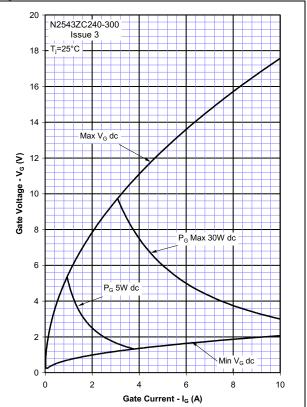


Figure 2 - Transient Thermal Impedance

Figure 4 - Gate Characteristics - Power Curves

Time (s)



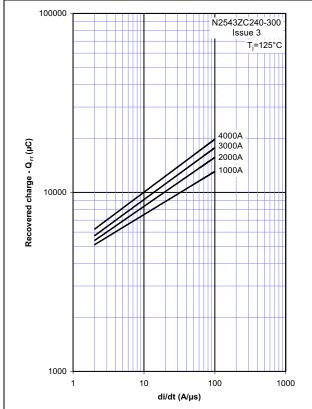


Figure 5 – Recovered Charge, Qrr

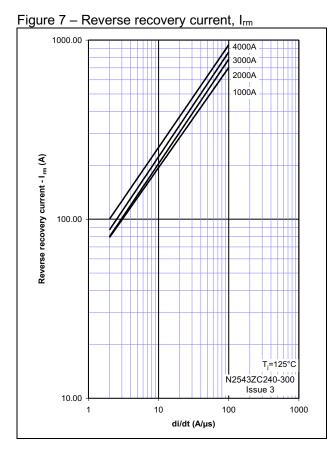


Figure 6 – Recovered charge, Qra (50% chord)

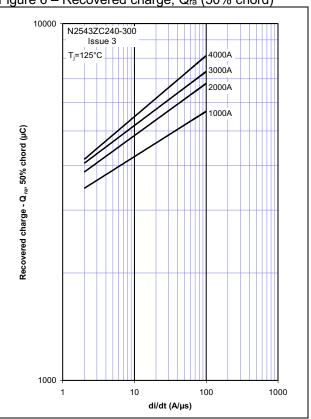
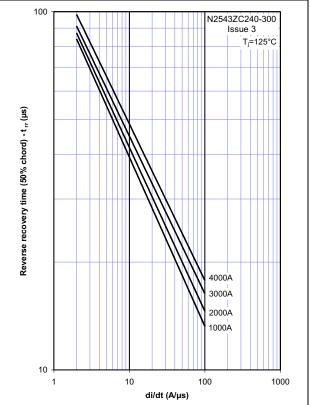


Figure 8 – Reverse recovery time, t<sub>rr</sub> (50% chord)



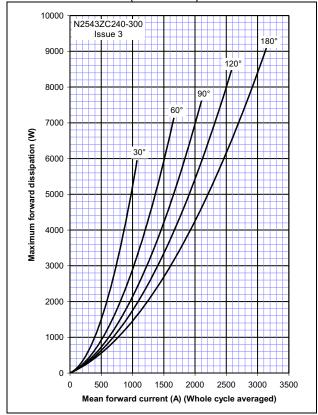


Figure 9 – On-state current vs. Power dissipation – Double Side Cooled (Sine wave)

Figure 10 - On-state current vs. Heatsink temperature - Double Side Cooled (Sine wave)

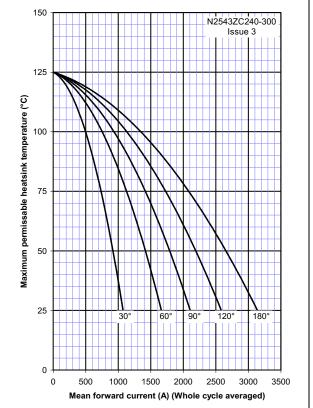
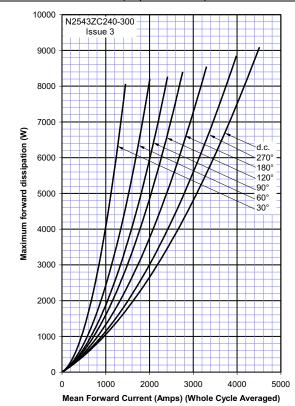
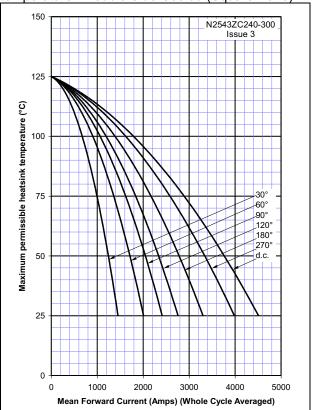


Figure 11 – On-state current vs. Power dissipation – Figure 12 – On-state current vs. Heatsink Double Side Cooled (Square wave)



temperature - Double Side Cooled (Square wave)



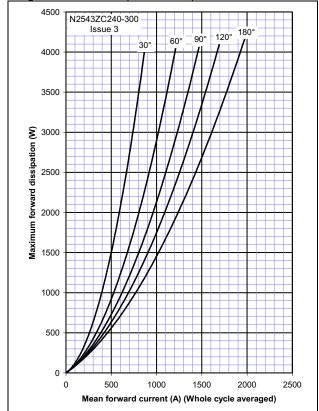


Figure 13 – On-state current vs. Power dissipation – Single Side Cooled (Sine wave)

Figure 14 – On-state current vs. Heatsink temperature - Single Side Cooled (Sine wave)

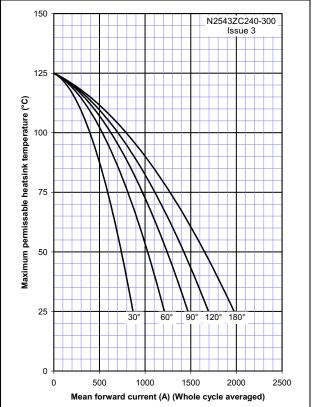
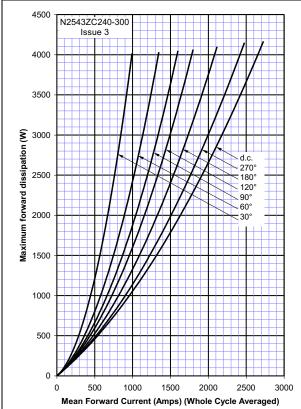
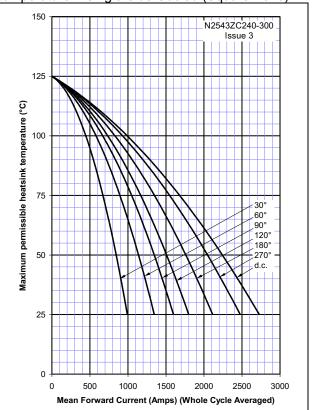


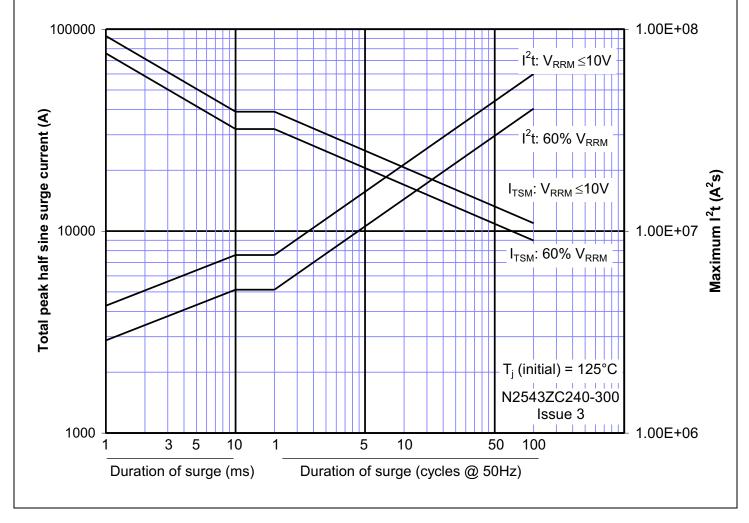
Figure 15 – On-state current vs. Power dissipation – Figure 16 – On-state current vs. Heatsink Single Side Cooled (Square wave)



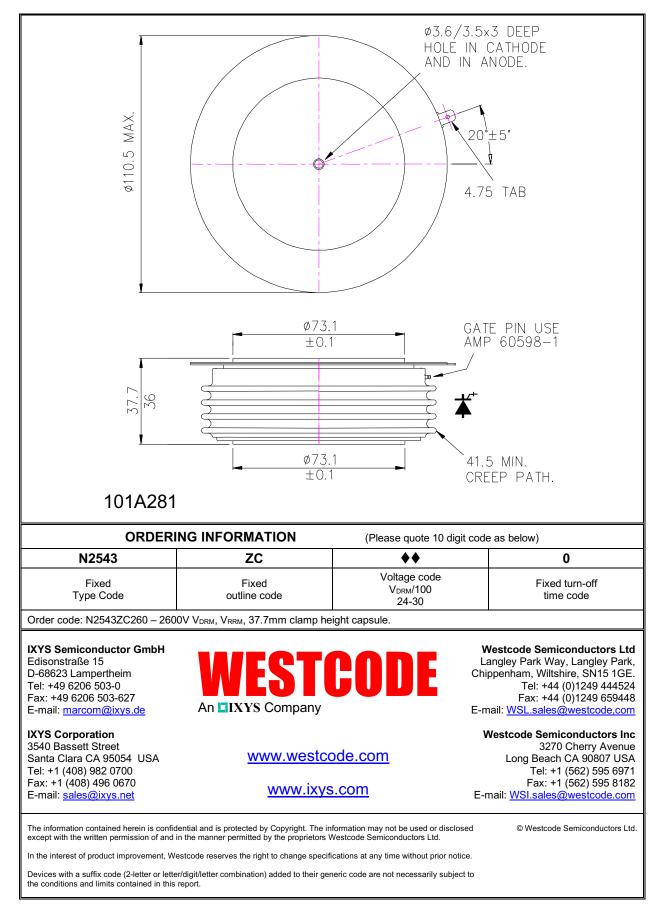
temperature - Single Side Cooled (Square wave)



# Figure 17 – Maximum surge and I<sup>2</sup>t Ratings



# **Outline Drawing & Ordering Information**





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